CMOS LSI



No. 1542

LC3101

128K-BIT CMOS MASK ROM

The LC3101 is a 128k-bit CMOS mask ROM that contains an interface connectable direct to the speech synthesizer LSI LC8100. With one piece of this mask ROM, approximately 100 seconds of speech synthesis can be attained. Since it also contains an interface connectable direct to an EPROM, speech synthesis can be attained by using this mask ROM and an EPROM jointly.

A selection of 8-bit, 4-bit, or single-bit output data is allowed by means of external control. This mask ROM is also suited for use in applications other than speech synthesis.

Features

- ROM capacity
- Access time
- Cycle time
- Function

128K bits

25.6µsec typ (for operation at 200kHz typ.)

- 30.6µsec typ (for operation at 200kHz typ.)
- (1) Contains an interface to an EPROM.
- (2) Contains an interface to the LC8100 (speech synthesizer LSI).
- (3) Possible to select the bit length of output data.
 - 8-bit data
 - 4-bit data
 - Single-bit data
- Low power dissipation
- Current dissipation
- Single +5V power supply-
- Package

CMOS

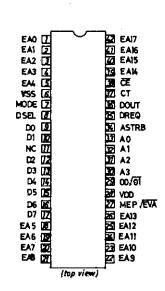
2mA max. (at operating mode)

 1μ A max. (at nonoperating mode)

+2.7 to 6.0 V (supply voltage range)

DIP24

Pin Assignment



Package Dimensions 3014A-D42IC

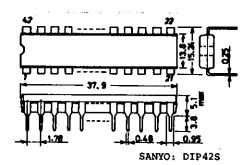
(unit: mm)

3.2

SANYO: DIP42

Package Dimensions 3025B-D42SIC

(unit: mm)



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Equivalent Circuit Block Diagram

A0 to A3:

18-bit address setting pins

ASTRB:

A0 to A3 strobe pin

DREQ:

ROM data request pin

DOUT: CT:

ROM data serial output pin Basic operation clock input pin

D0 to D7:

8-bit input/output pins

MODE:

DREQ pin input pulse count control pin

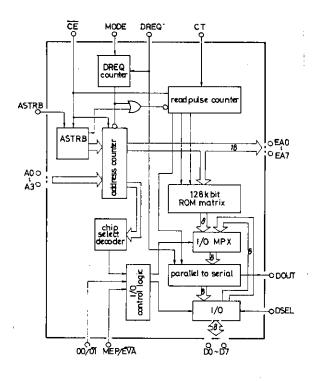
DSEL:

Output bit length select pin

CE:

Power-down control pin

EA0 to EA17: 18-bit address output pins



Description of Operation of Internal Block

ASTRB COUNTER:

Block which internally sets address information applied in 5 steps from A0 to A3

pins.

18bit ADDRESS COUNTER: Address counter organized with 18 bits.

READ PULSE COUNTER:

Block which generates signal to operate address decoder, data selector.

CHIP SELECT DECODER:

Makes chip select signal with 214 to 217 bits of 18-bit address.

128kbit ROM MATRIX:

ROM matrix cell organized with 128K bits.

PARALLEL TO SERIAL:

Shift register which serially outputs 8-bit parallel data to DOUT pin.

I/O PORT:

Selects input/output at D0 to D7 pins.

Pin Description

Pin No.	n No. Pin Name Input/outpu		Function		
34 ASTRB		Input	Pin for inputting strobe signal which causes data A0 to A3 to be latched at address setting mode.		
35	DREQ	Input	ROM data request signal input pin.		
36	DOUT	Output	Pin for outputting ROM data serially. When used in conjunction with the LC8100, this pin is connected to DIN pin of the LC8100.		
37	ст	Input	Pin for inputting basic operation clock of ROM inside. When used in conjunction with the LC8100, this pin is connected to CT pin of the LC8100.		

Pin No.	Pin Name	Input/output	Function		
38	CE	Input	Pin for controlling initialization of LSI inside immediately after application of power and interroperation stop (power-down). For performi synthesization or ROM data read-out, set CE 'L'.		
6	VSS	. —	Connected to 0V of power supply.		
28	V _{DD}	_	Connected to + side of power supply.		
29	00/01	Input	Always set to VSS		
7	MODE	Input	Pin for controlling number of input pulses at DREQ pin. When ROM data read-out is performed serially in a single bit, set MODE to 'L'. When ROM data read-out is performed in 8 bits or 4 bits, set MODE to 'H'. Used when ROM data read-out is performed in 4 bits. When DSEL is set to 'H', 24 to 27 bits are outputted to D0 to D3 pins.		
8	DSEL	Input			
9	D0		Pins for outputting ROM data in 8 bits and inputting		
10	D1		data in 8 bits.		
12	D2				
13	D3	Input/output	•		
14	D4				
15	D5				
16	D6		49.5		
17 ————	D7				
27	MEP/EVA	Input	Open or connected to V _{DD} .		
30	А3		Pins for setting 18-bit address. At address setting		
30 31	A3 A2	Input	Pins for setting 18-bit address. At address setting mode, address information is inputted by 4 bits		
		Input	mode, address information is inputted by 4 bits		
31	A2	Input			
31 32 33	A2 A1 A0		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32	A2 A1 A0 EA0	Input	mode, address information is inputted by 4 bits		
31 32 33 1 2	A2 A1 A0		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33	A2 A1 A0 EA0 EA1		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2	A2 A1 A0 EA0 EA1 EA2		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5	A2 A1 A0 EA0 EA1 EA2 EA3		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20 21	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6 EA7 EA8		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20 21 22	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6 EA7 EA8 EA9		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20 21 22 23	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6 EA7 EA8 EA9 EA10		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20 21 22 23 24	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6 EA7 EA8 EA9 EA10 EA11		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20 21 22 23 24 25	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6 EA7 EA8 EA9 EA10 EA11 EA12		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20 21 22 23 24 25 26	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6 EA7 EA8 EA9 EA10 EA11 EA12 EA13		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20 21 22 23 24 25 26 39	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6 EA7 EA8 EA9 EA10 EA11 EA12 EA13 EA14		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		
31 32 33 1 2 3 4 5 18 19 20 21 22 23 24 25 26	A2 A1 A0 EA0 EA1 EA2 EA3 EA4 EA5 EA6 EA7 EA8 EA9 EA10 EA11 EA12 EA13		mode, address information is inputted by 4 bits from high-order bit downward in 5 steps.		

How to use the mask ROM and an EPROM jointly

The mask ROM and an external EPROM can be used jointly. Two selections of operation mode shown below are available by high-order 4 bits (EA14 to EA17) of 18-bit address.

Operation Mode Pins	D0 to D7	
(1)	Output	The mask ROM contents are delivered at pins D0 to D7 and DOUT.
(2)	Input	The EPROM output contents are read in from pins D0 to D7 and are delivered at pin DOUT.

How to select the operation mode

The LC3101 contains a 4-bit chip select decoder (user option: Refer to "User mask"). Coincidence or uncoincidence with high-order 4 bits (EA14 to EA17) of 18-bit address is detected to select the operation mode.

Operation Mode	4bits of Chip Select Decoder	Operation of LC3101
(1)	Coincidence with EA14 to EA17	Pins D0 to D7: Output mode
117		Mask ROM read enable mode
(2)	Uncoincidence with EA14 to EA17	Pins D0 to D7: Input mode
		Mask ROM read inhibit mode

Fig. 1 shows the schematic diagram of the control section related to these operation modes. Fig. 2 shows the assignment of 256k-byte (128k bits x 16) that can be specified by 18-bit address.

Fig. 1 Schematic Diagram of Control Section

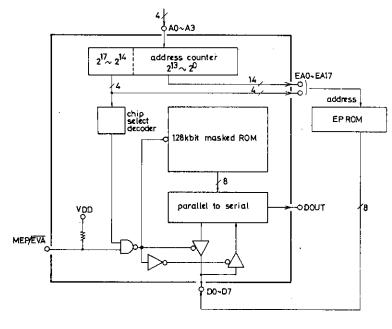
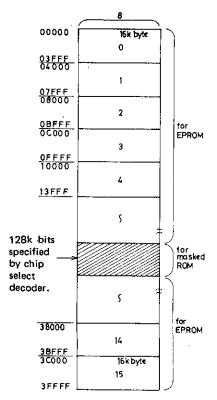
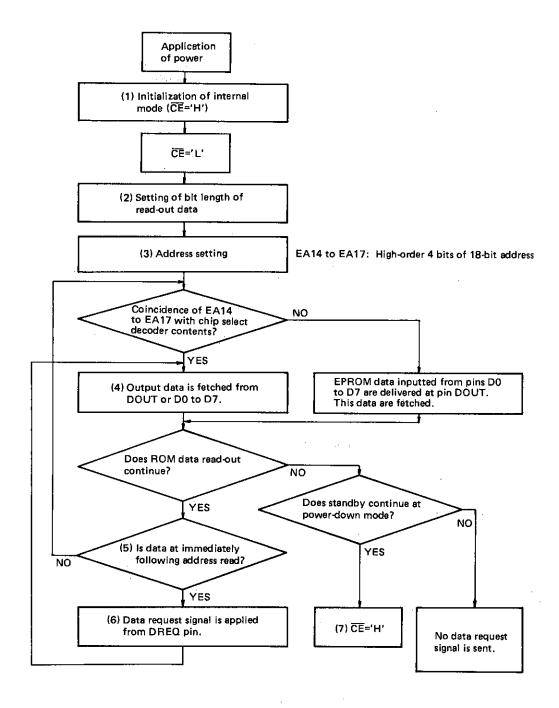


Fig. 2 Address Space Assignement



ROM Data Read-out Procedure

The following flowchart shows the outline of read-out procedure. (1) to (7) give a more detailed description.



(1) Initialization of internal mode

There are 4 counter blocks (ASTRB counter, 18-bit ADDRESS counter, READ PULSE counter, DREQ counter) inside the LC3101. Since initialization is required immediately after application of power, apply one 'H' level pulse to \overline{CE} pin. When \overline{CE} is set to 'L' level, the power-down mode is released (refer to (7)) and it is possible to start read-out any time.

(2) Setting of bit length of read-out data

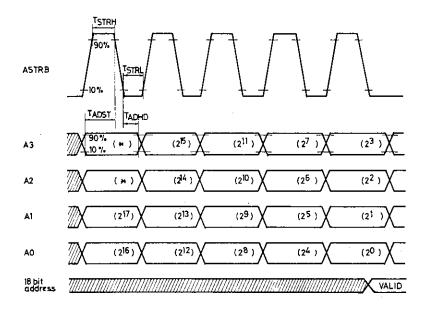
For the bit length of ROM data output, a selection of 3 lengths is allowed: 8 bits, 4 bits, and a single bit. For controlling this selection, MODE, DSEL pins are used. The following Table shows 3 types of pin setting.

MODE DSEL.	'L'	"H"
"L"	Single-bit length (speech synthesis)	8-bit or 4-bit length or 4-bit length (Note)
' H'	_	4-bit length (Note)

(Note) When DSEL is set to 'L', 20 to 23 bits are outputted at D0 to D3 pins. When DSEL is set to 'H', 24 to 27 bits are outputted at D0 to D3 pins.

(3) Address setting

Apply 5 successive pulses to ASTRB pin. Synchronously with these pulses apply 18-bit address information to A0 to A3 pins from high-order bit downward by 4 bits in 5 steps. At this address setting mode DREQ pin must be set to 'L' level. Shown below is the timing.



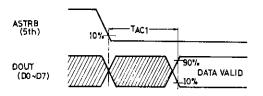
(Note) • """=don't care.

- "2n"=Binary number at the nth bit to be set in address counter.
- For the numeric values of TSTRH, TSTRL, TADST, TADHS, refer to Electrical Characteristics.

Start of read-out of set address data

Read-out of ROM data starts at the falling of the 5th ASTRB pulse or the first (MODE='H') or the 8th (MODE='L') DREQ pulse, and when access time T_{AC1} has elapsed 2^0 bit is outputted at DOUT pin and 2^0 to 2^7 data are outputted at D0 to D7 pins. (Refer to the following Timing Chart.)

Note) For the numeric value of TAC1, refer to Electrical Characteristics.



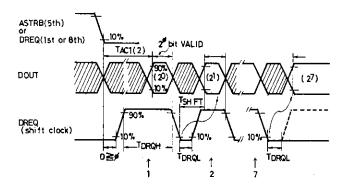
(4) Fetching of output data

As shown above, whenever access time TAC1 has elapsed, data can be fetched from output ports DOUT or D0 to D7 pins. (Pin setting as shown in Table in (2) is required.)

Counting one byte in a single bit from DOUT pin

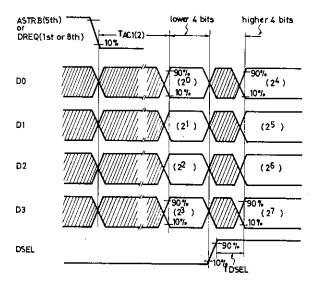
Count a single bit (2ⁿ bit) from DOUT pin. To count the following single bit (2ⁿ⁺¹ bit), apply a shift clock to DREQ pin. Shown below is Timing Chart.

For the numeric values of TAC1, TDRQH, TSHFT, refer to Electrical Characteristics.



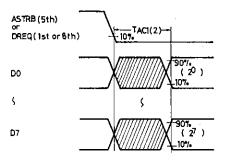
Counting one byte in 4-bits from D0 to D3 pins

In accordance with Table and (Note) in (2), fetch one byte from D0 to D3 pins by 4 bits in 2 steps. Shown below is Timing Chart.



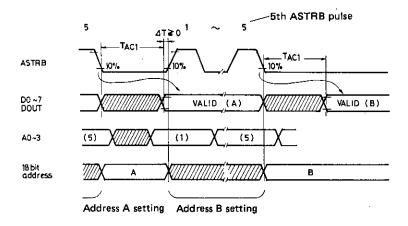
Counting one byte in 8 bits from D0 to D7 pins

Fetch 8 bits from D0 to D7 pins. Shown below is Timing Chart.

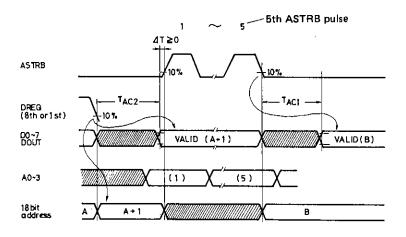


(5) Setting address again and counting data

(1) Timing for application of ASTRB pulse when address A is set and read out and then address B is set and read out.



(2) Timing for application of ASTRB pulse when data is read out by application of DREQ signal (refer to (6) below) and then address B is set and read out.

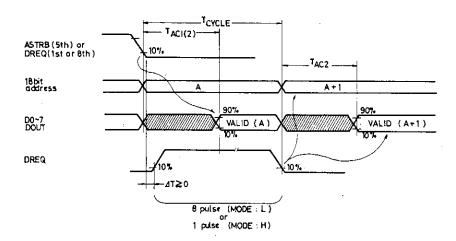


(6) Request of ROM data at the following address

When the signal shown below is applied to the LSI, the LSI begins to read out data at the address immediately following the address at which preceding data is read out.

Falling of 8th DREQ pulse (MODE='L')
Falling of 1st DREQ pulse (MODE='H')

Shown below is Timing Chart.



Note) Apply ROM data request signal after TCYCLE or more has elapsed.

For the numeric value of TCYCLE, refer to Electrical Characteristics.

(7) Power-down mode

When the input at \overline{CE} pin is set to 'H' level, the LC3101 enters power-down mode (each block inside the LSI stops its operation, with no unnecessary current dissipated.). At this mode, the LSI inside becomes as follows and current dissipation is reduced.

- (1) Input at input ports (ASTRB, DREQ, A0 to A3) is inhibited.
 (It should be noted that if input is floating, current dissipation increases.)
- (2) Both address decoder and data selector in 128K-bit ROM matrix stop their internal operation.
- (3) Output at 3-state output pins DOUT, D0 to D7 is floating or fixed. (The user can select either of the two. Refer to "User mask") When \overline{CE} is set to 'H', in addition to reduction in current dissipation as mentioned above, 4 internal counters (ASTRB COUNTER, 18-BIT ADDRESS COUNTER, READ PULSE COUNTER, DREQ COUNTER) are initialized in readiness for read-out after power-down mode release (\overline{CE} ='L').

User mask

(1) CHIP SELECT DECODER

User mask option which makes LSI chip select signal (select, nonselect) with 2¹⁴ to 2¹⁷ bits of 18-bit addresses. Shown below is the output modes including CE pin conditions.

	CE='L'	CE='H' (Power-down)			
Chip select	DATA is outputted from DOUT, D0 to D7 pins.	Data immediately before \overline{CE} ='H' occurs is held and outputted. (Note)			
Chip nonselect	Output at DOUT, D0 to D7 pins has a high impedance.	Output at DOUT, D0 to D7 pins has a his impedance.			

Note) In this case, the LSI only, having CHIP SELECT DECODER whose 2¹⁴ to 2¹⁷ bits are all 0, outputs data and all others have a high impedance.

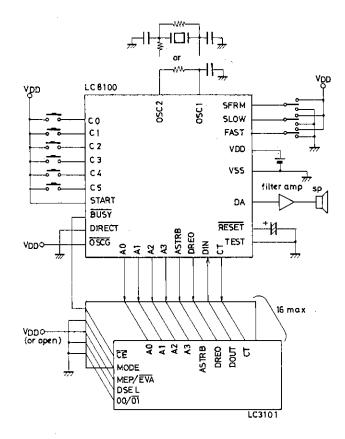
(2) SW mask

SW mask controls output at DOUT, D0 to D7 output pins in the following two ways at power-down mode. The user can select either of the two beforehand.

- (i) Output at DOUT, D0 to D7 pins is set to a high impedance.
- (ii) Data immediately before power-down mode is held and outputted.

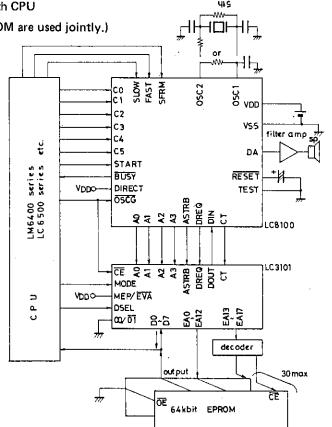
Sample Application Circuit (1)

One word to one key correspondence



Sample Application Circuit (2)

CPU control: Edit and synthesis with CPU (The mask ROM and a 64k-bit EPROM are used jointly.)



Absolute Maximum Ratings at Ta=2	25°C. Vee=0V				,	unit
Maximum Supply Voltage	VDD max	V _{DD} pin		-3.0	to +7.0	V
Input Voltage	VIN	All input pins	-0.3		D+0.3	V
Output Voltage	νo	All output pins			D+0.3	v
Output Current	lo	All output pins, per pin	0,0		to +2,0	mA
Allowable Power Dissipation	P _d max	T _a =-30 to +70°C		2,0	200	mW
Operating Temperature		1a30 to +70 C		_30	to +70	°C
Storage Temperature	Topr T				o +125	°C
Otorage Temperature	T_{stg}			-55 (0 + 125	C
Allowable Operating Ranges at Ta=-	–30 to +70°C, \	/ _{SS} =0V, V _{DD} =4.5 to 6.5V	min	typ	max	unit
Supply Voltage	, V_{DD}	VDD pin	4.5	5.0	6.5	V
Input 'H'-Level Voltage	VIH(1)	All input pins other than 0 D0 to D7	.7V _{DD}			V
4.	V _{IH} (2)	D0 to D7 pins	2.2			V
Input 'L'-Level Voltage	VIL(1)	All input pins other than		0.	3V _{DD}	V
	•••	D0 to D7				
	V _{IL(2)}	D0 to D7 pins			0.6	V
Operating Clock Frequency	fCT	Fig. 1, T _a =-30 to +60°C	- 150	800	960	kHz
Operating Clock 'H'-Level Pulse Width	^t wOH	Fig. 1	0.3		9,	μs
Operating Clock 'L'-Level	twOL	Fig. 1	0.47			μs
Pulse Width	 02	•	•			μυ
Electrical Characteristics at Ta=-30	to +70°C, V _{DD})=4.5 to 6.5V, V _{SS} =0V	min	typ	max	unit
Input 'H'-Level Current	11Н	V _{IN} =V _{DD}			1.0	μΑ
Input 'L'-Level Current	l _{IL}	V _{IN} =V _{SS}	-1.0			μΑ
Output 'H'-Level Voltage	Vон	· · · · · · · · · · · · · · · · · · ·	D-0.6			v
Output 'L'-Level Voltage	VOL	IOH=0.3mA			0.6	V
Output OFF Leak Current	IOFF1	V _O =V _{DD} , D0 to D7, D _{OUT} pin			1.0	μĀ
	IOFF2	Vo=Vss, D0 to D7, Dout pin	-1.0			μΑ
Input Pin Capacitance	CI	G 667		5	10	ρF
Pull-up Resistance	Rup	Each pin of MEP/EVA, 00/01	20	•	1000	kΩ
Current Dissipation	¹ DD(1)	At operating mode, fCT=960kHz			2.0	mΑ
·	IDD(2)	At nonoperating mode, T _a =-30 t	-		1.0	μΑ
	100(2)	Fig. 2	.0 .00 0,		1.0	μ
AC Characteristics at T _a =-30 to +70	0°C, V _{DD} =4.5 1	o 6.5V, V _{SS} =0V, R _L =200kohm, Cl	P=50pF			
			min	typ	max	unit
Address Setup Time	TADST	Fig. 3	0.3			μs
Address Hold Time	TADHD	Fig. 3	0.3			μs
ASTRB 'H'-Level Pulse Width	TSTRH		0.3		٠	μs
ASTRB 'L'-Level Pulse Width	TSTRL		0.3			μs
DREQ 'H'-Level Pulse Width	TDRQH		0.3			μs
DREQ 'L'-Level Pulse Width	TDROL		0.3			μs
ASTRB Pulse Duration	TASTRB	Fig. 3	1.5			μs
DREQ Pulse Duration	TDREQ	Fig. 4	1.5			μs
ROM Data Access Time (1)	TAC1	fcT=200kHz typ., Fig. 5, Note 1	26.0			μs
ROM Data Access Time (2)	TAC2	fCT=200kHz typ., Fig. 5, Note 1	26.0			μs
DREQ TO DOUT Delay Time	TSHFT	Fig. 6	0.6			μs
DSEL TO D0-3 Delay Time	TDSEL	Fig. 7	0.3			μs
Cycle Time	TCYCLE	fCT=200kHz typ., Fig. 8, Note 1	30.6			μs
•	J. JLL	O1	50.0			μο

Fig. 1 Input waveform at CT pin

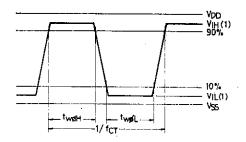
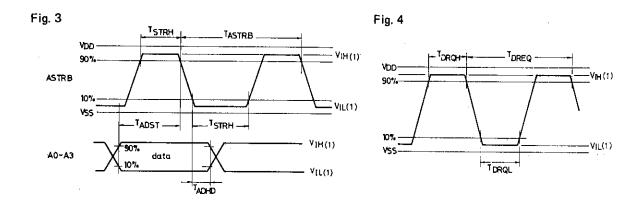


Fig. 2 LC3101 LC3101 LC3101 D7 D6 D5 D3 D3 D1 D0 D5 D4 D3 D2 D1 D0 D6 D5 D4 D3 D2 D1 D0 EA13 EA12 EA10 EA 8 EA 7 EA 6 EA 5 EA 2 EA 2 EA 0 Open Open Open DOUT τυρα TUOQ Open Open Open MEP/EVA 960kHz -Open -00/01 MER/ EVA MEP/EVA MODE 00/01 MODE 00/01 ÇΕ VDD 1(4) I DD (1) Test Circuit (A) 1 DD (1) Test Circuit (B) 100(2) Test Circuit





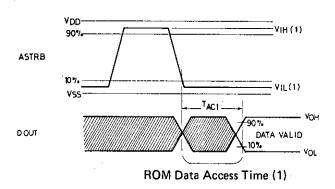
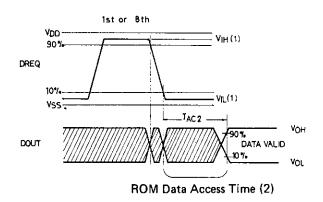
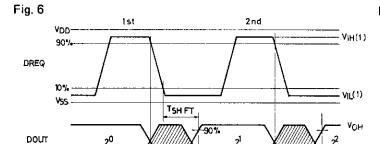


Fig. 5 (2)





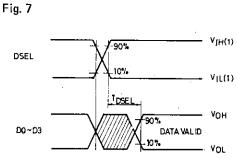
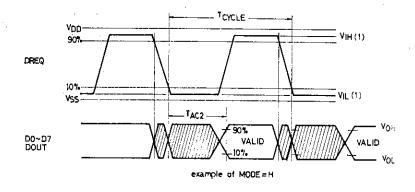


Fig. 8



Note 1 Use the following formulas to calculate TAC max, Tcycle max. T AC max =
$$\frac{5000}{\text{f cT (kHz)}} + 0.6 \mu \text{ s}$$
 T cycle max = $\frac{6000}{\text{f cT (kHz)}} + 0.6 \mu \text{ s}$

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